



CW1051

3~5 Channel Secondary Protection IC

Features

- 3~5 Cells Application
- Overcharge Protection
 - Threshold from 4.100V to 4.500V
 - 25mV Steps, $\pm 25\text{mV}$ Accuracy
- Internal Overcharge Protection Delay Time
- Overcharge Delay Counter Reset Time
- Open Wire Protection
- Low Power Dissipation
 - Normal Working $4\mu\text{A}$ (25°C)
- Package Type: MSOP8L, DFN3*4-8L

Applications

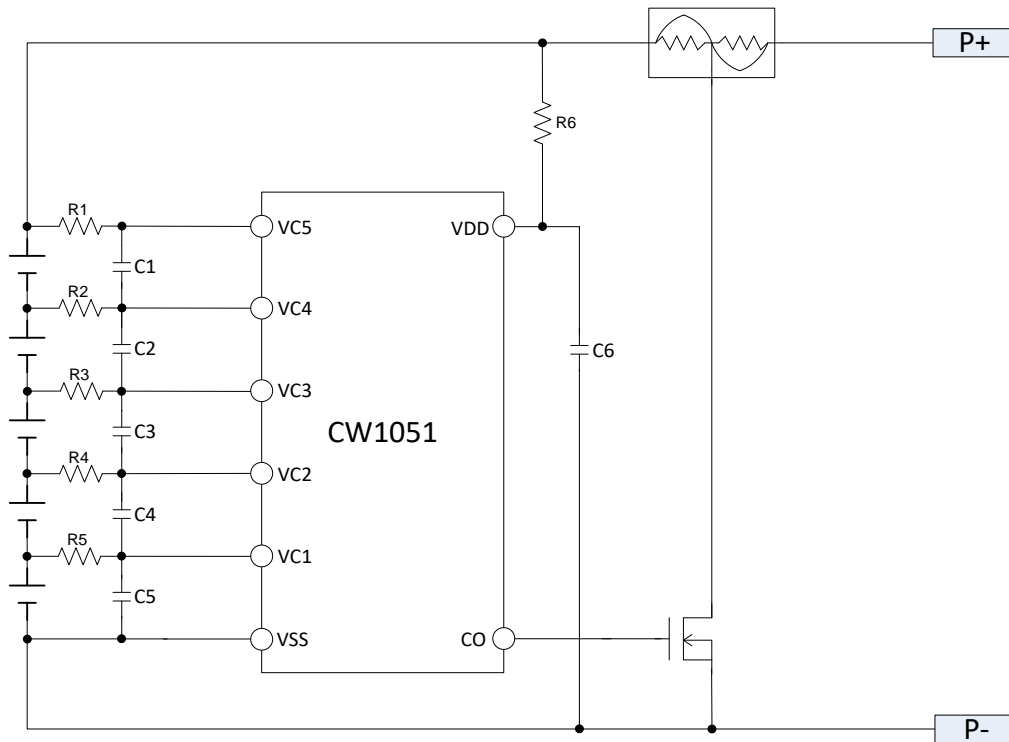
- NoteBook
- Tablet PC
- E-Tools
- Backup Power Supply
- Other Lithium-ion or Lithium Polymer Battery Packs

General Description

The CW1051 series products are highly integrated secondary protection ICs for 3 to 5 lithium-ion and lithium polymer battery cells connected in series. CW1051 provides overcharge protection for battery pack by measuring each cell's voltage.

Application Circuits

For 5 cell connect in series (CMOS, Active H)

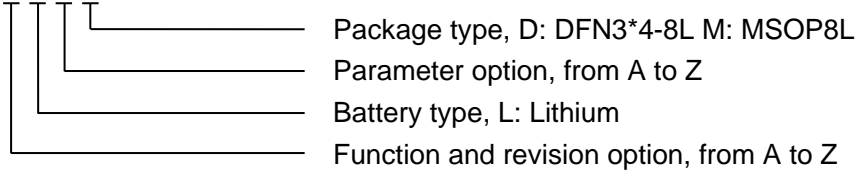


Recommended parameter

| SYMBOL | TYPICAL | RANGE | UNIT |
|----------------|---------|----------|------|
| R1,R2,R3,R4,R5 | 1000 | 200~2000 | Ω |
| R6 | 200 | 200~1000 | Ω |
| C1,C2,C3,C4,C5 | 0.1 | 0.1~0.22 | μF |
| C6 | 0.1 | 0.1~0.47 | μF |

Product Name

CW1051 X X X X

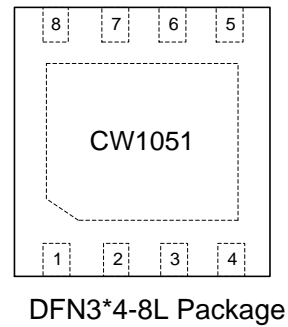
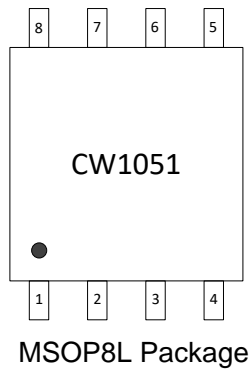


Ordering Information

| TYPE | OVER CHARGE THRESHOLD [VOC] (V) | HYSTERESIS VOLTAGE*1 [VHYS] (V) | DELAY TIME*2 [TOC] (S) | OUTPUT TYPE*3 |
|------------|---------------------------------|---------------------------------|------------------------|---------------------------|
| CW1051ALAM | 4.220 | 0.300 | 1 | CMOS, Active H |
| CW1051ALAD | | | | CMOS, Active L |
| CW1051ALBM | 4.220 | 0.050 | 6 | CMOS, Active H |
| CW1051ALBD | | | | |
| CW1051ALCM | 4.350 | 0.050 | 1 | CMOS, Active H |
| CW1051ALCD | | | | |
| CW1051ALDM | 4.400 | 0.300 | 4 | CMOS, Active H |
| CW1051ALDD | | | | |
| CW1051ALEM | 4.220 | 0.300 | 1 | CMOS, Active H |
| CW1051ALED | | | | |
| CW1051ALFM | 4.300 | 0.300 | 4 | CMOS, Active H |
| CW1051ALFD | | | | |
| CW1051ALGD | 4.300 | 0.050 | 2 | NMOS open drain, Active L |
| CW1051ALGM | | | | |
| CW1051ALHD | 4.275 | 0.050 | 1 | CMOS, Active H |
| CW1051ALHM | | | | |
| CW1051ALJM | 4.250 | 0.100 | 1 | NMOS open drain Active L |
| CW1051ALKM | | | | |
| CW1051ALLM | 4.250 | 0.300 | 1 | CMOS, Active L |
| CW1051ALMM | 4.200 | 0.050 | | NMOS open drain Active L |
| CW1051ALMD | 4.200 | 0.050 | | CMOS, Active H |
| CW1051ALOM | 4.250 | 0.100 | 4 | CMOS, Active H |
| CW1051ALPM | 4.175 | 0.100 | 1 | CMOS, Active L |
| CW1051ALQD | 4.350 | 0.300 | 4 | CMOS, Active H |
| CW1051ALSM | 4.200 | 0.100 | 1 | CMOS, Active H |
| CW1051ALRM | 4.200 | 0.100 | 1 | CMOS, Active L |
| CW1051ALUM | 3.800 | 0.100 | 1 | CMOS, Active H |

- *1 Optional hysteresis voltage: 0V, 0.050V, 0.100V, 0.300V
- *2 Optional delay time: 1s, 2s, 4s, 6s
- *3 Optional output type: CMOS active H, CMOS Active L, PMOS open drain Active H, NMOS open drain Active L

Pin Configuration



Pin Descriptions

| PIN | NAME | DESCRIPTION |
|-----|------|--------------------------|
| 1 | VDD | Power supply |
| 2 | VC5 | Positive input of cell5 |
| 3 | VC4 | Positive input of cell4 |
| 4 | VC3 | Positive input of cell3 |
| 5 | VC2 | Positive input of cell2 |
| 6 | VC1 | Positive input of cell1 |
| 7 | VSS | Ground |
| 8 | CO | Overcharge output driver |

Absolute Maximum Ratings

| | | VALUE | | UNITS |
|----------------------------------|------------------|-------|---------|-------|
| | | MIN | MAX | |
| PIN voltage range respect to VSS | VDD, VCx | -0.3 | 36 | V |
| PIN voltage range respect | CO | -0.3 | VDD+0.3 | V |
| Operation Temperature | | -30 | 85 | °C |
| Storage Temperature | T _{stg} | -40 | 125 | °C |

Caution:

Stresses beyond "Absolute Maximum Ratings" condition may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ESD Ratings

| | | | MAX | UNITS |
|---------------------------|-------------------------|---|-------|-------|
| V _(ESD) Rating | Electrostatic discharge | Human body model (HBM) ESD stress voltage | ±4000 | V |
| | | Charged device model (CDM) ESD stress voltage | ±1000 | V |

Recommended DC Operating Conditions

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
|-------------------------|-----------------|------------|-----|-----|-----|-------|
| VDD Input Voltage Range | V _{DD} | | 4.5 | | 28 | V |
| VCx Input Voltage Range | V _{Cx} | | 0 | | 4.5 | V |

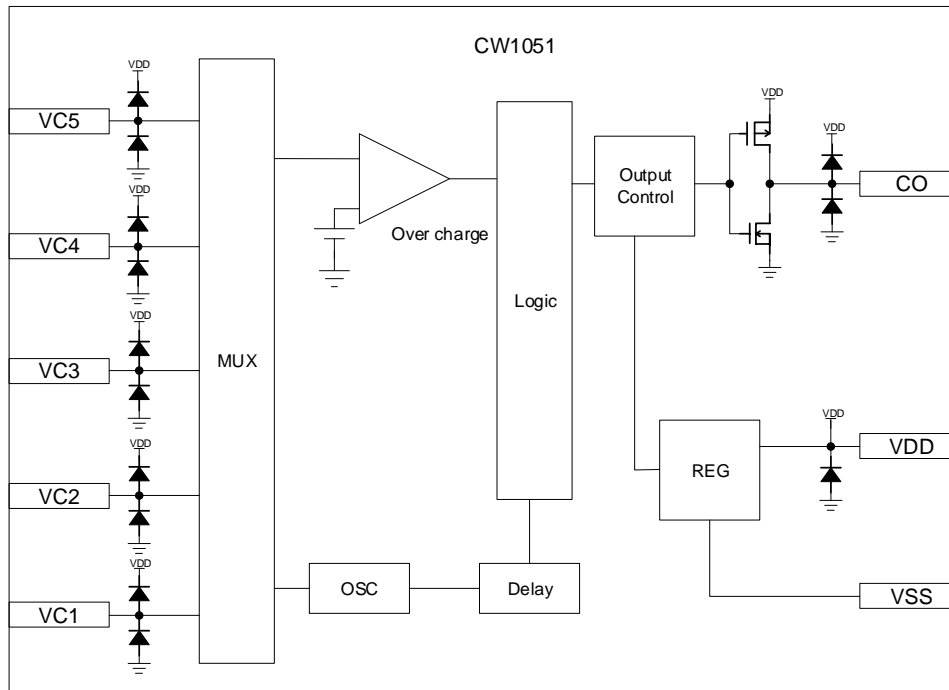
Electrical Characteristics

Operation under 25°C unless otherwise specified

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
|--|-------------|---|---------------------|-----------|---------------------|---------|
| INPUT CURRENT | | | | | | |
| Operation Current | I_{OPR} | VC1=VC2=VC3=VC4=VC5=3.7V | | 4 | 7 | μA |
| VOLTAGE/TEMPERATURE DETECT AND PROTECTION THRESHOLD | | | | | | |
| Overcharge Threshold | V_{OC} | VC1=VC2=VC3=VC4=3.7V Sweep VC5 from 3.7V to 4.5V | V_{OC-} 0.025 | V_{OC} | V_{OC+} 0.025 | V |
| Overcharge Threshold in whole Temperature Range | | From -5°C to 55°C | V_{OC-} 0.040 | V_{OC} | V_{OC+} 0.040 | V |
| OC Release Threshold $V_{OCR}=V_{OC-}V_{HYS}$ | V_{OCR} | VC1=VC2=VC3=VC4=3.7V Sweep VC5 from 4.5V to 3.7V | V_{OCR-} 0.025 | V_{OCR} | V_{OCR+} 0.025 | V |
| ACTION DELAY | | | | | | |
| Overcharge Delay | T_{OC} | VC1=VC2=VC3=VC4=3.7V Sweep VC5 from 3.7V to 4.5V | 0.80* T_{OC} | T_{OC} | 1.30* T_{OC} | s |
| Overcharge Release Delay | T_{OCR} | VC1=VC2=VC3=VC4=3.7V Sweep VC5 from 4.5V to 3.7V | | 5 | | ms |
| Overcharge Reset Delay | T_{RESET} | | | 20 | | ms |
| Open-wire Detection Delay | T_{OW} | Input capacitor = 0.1 μF | | 2 | | s |
| Open-wire Release Delay | T_{OWR} | | | 10 | | ms |
| PIN OUTPUT VOLTAGE | | | | | | |
| CO Logic High Output | V_{OC} | VC1=VC2=VC3=VC4=VC5=3.7V | V_{DD-} 0.3 | | | V |
| CO Logic Low Output*1 | | VC1=VC2=VC3=VC4=VC5=4.5V | | | 0.3 | V |
| PIN DRIVE ABILITY | | | | | | |
| CO High Output Drive Ability | CO | CO logic HIGH | | 35 | | μA |
| CO Low Output Drive Ability | | CO logic LOW | | 0.5 | | mA |

*1 There is several output types, detail please refer to the product selection table. Take CMOS Active H for example here.

Functional Block Diagram



Notes: Some buffer blocks omitted

Detailed Description

Normal State

CW1051 works under a normal state when each cell voltage is less than V_{oc} .

Overcharge State

When any cell voltage becomes higher than overcharge threshold voltage (V_{OC}) and stays longer than overcharge protection delay time (T_{OC}), CO will output a high-level signal, and CW1051 enters over charge state. CO signal can be used to inform the external device or control the MOSFET. If within T_{OC} , cell voltage drops lower than V_{OC} but stays shorter than overcharge reset delay time (T_{RESET}) before rising up over V_{OC} again, this spike will be ignored. Otherwise, accumulated delay time of overcharge will be reset. Overcharge protection state will release when all the cell voltages are less than the overcharge release threshold (V_{OCR}) and stay longer than the release delay time (T_{OCR}).

Open-wire Detection

Any wire connected between the battery cell and IC will be monitored.

When the wire disconnects and maintains (T_{OW}) time, IC will enter to the open-wire protection state.

CO outputs a high-level voltage to cut off the charge loop.

Open-wire protection will release when all wires reconnect and stay longer than the release delay time (T_{OWR}).

Test Mode

Test mode is used to reduce the protection delay time for test of mass production.

CW1051 will enter the test mode when add a $V_{DD}+7V$ voltage on VDD pin and maintains 80ms. Test mode lasts 8s then recovers to the normal status.

Detailed test mode timing is illustrated as bellow:

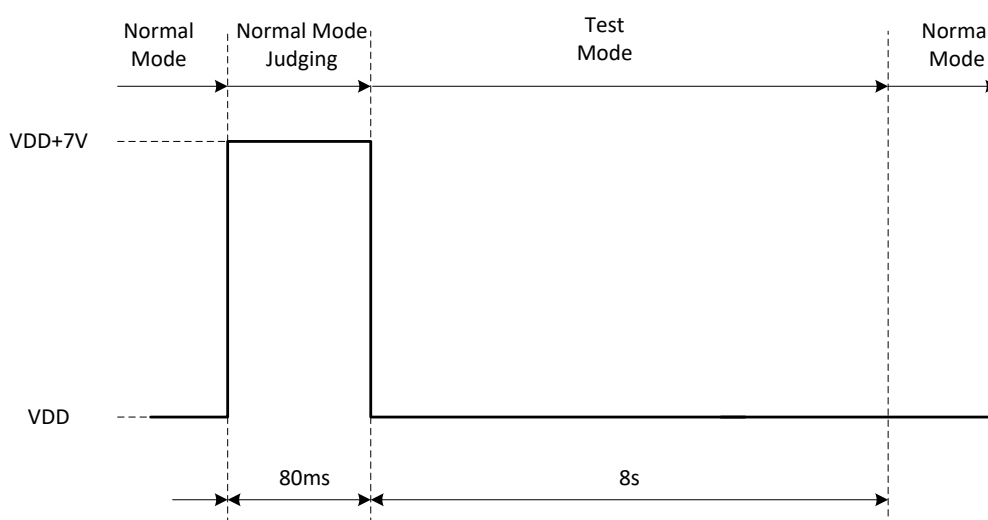
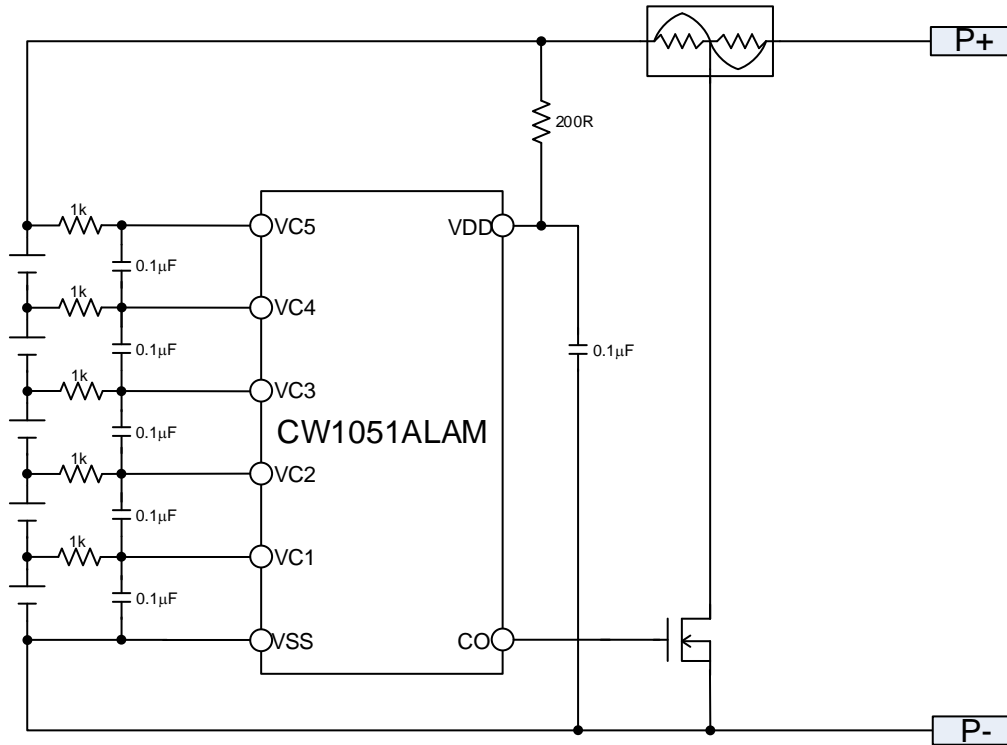
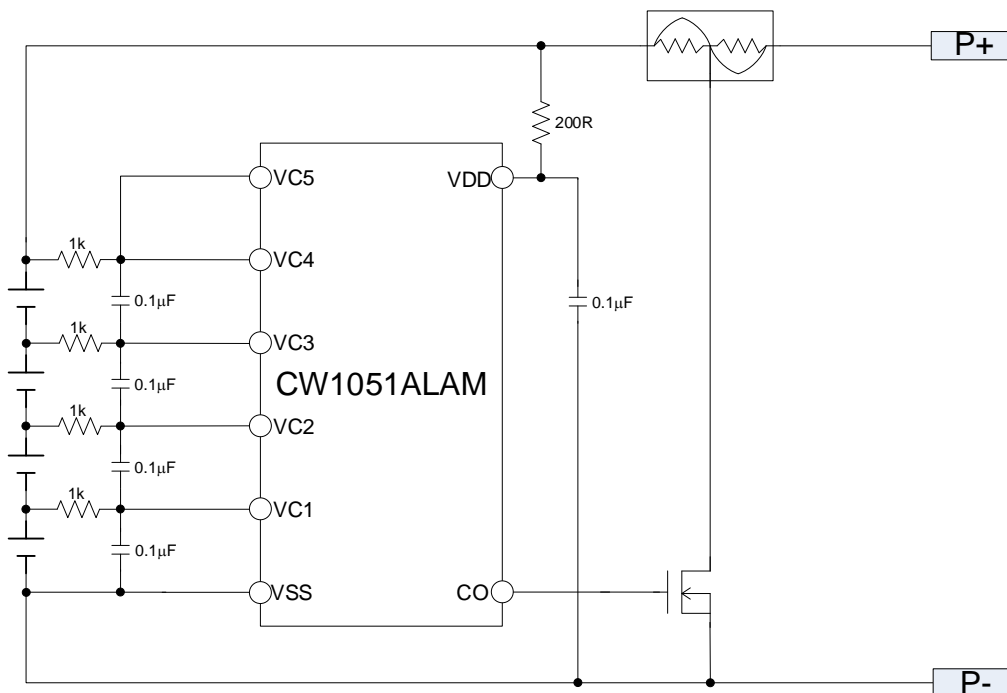


Figure 1. Test Mode Timing

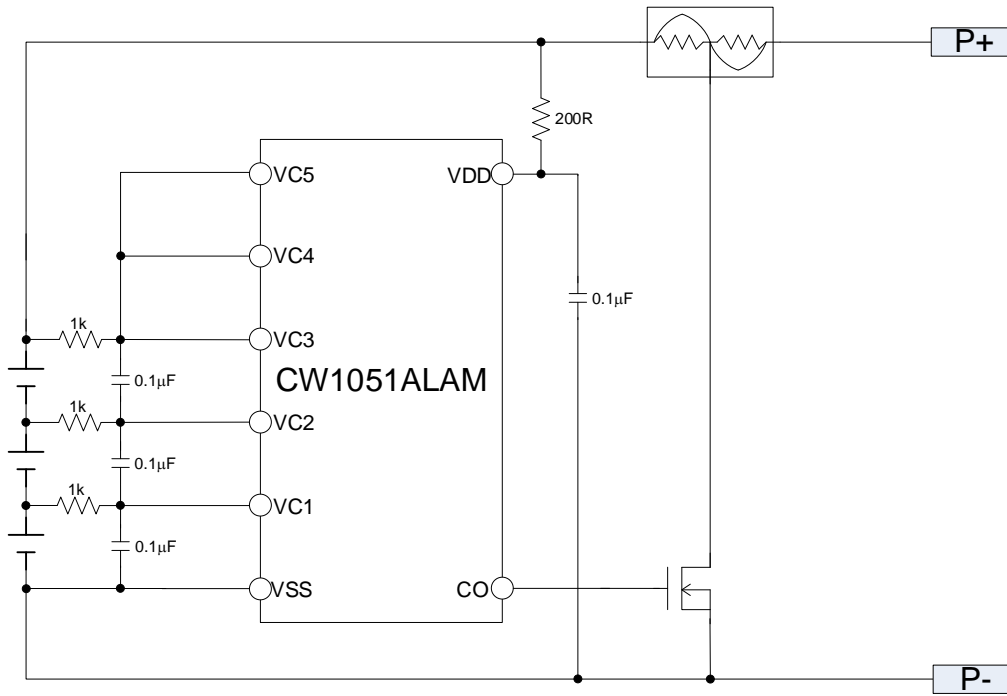
Reference Schematic



Reference Schematic for 5 cells



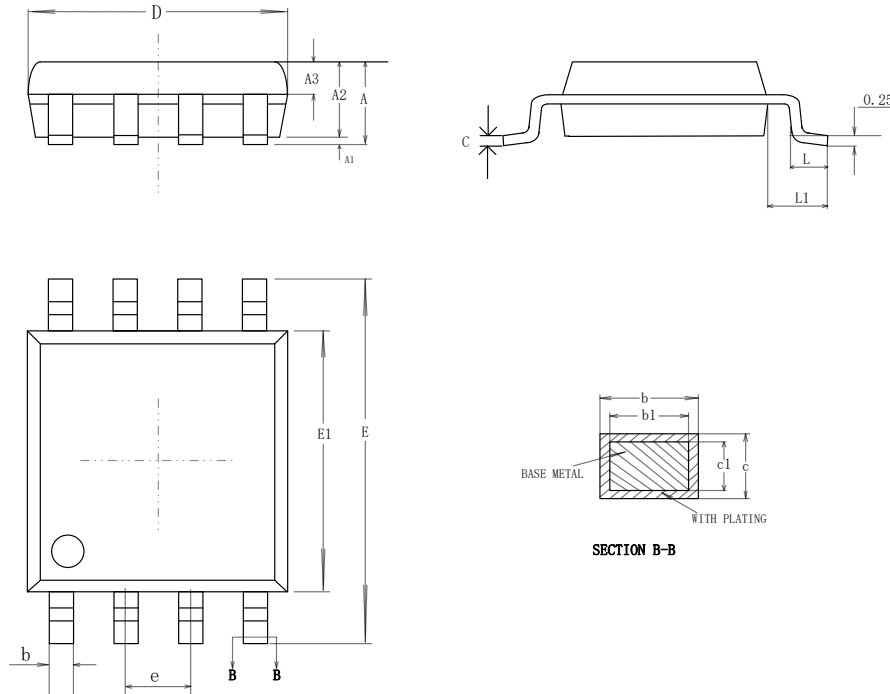
Reference Schematic for 4 cells



Reference Schematic for 3 cells

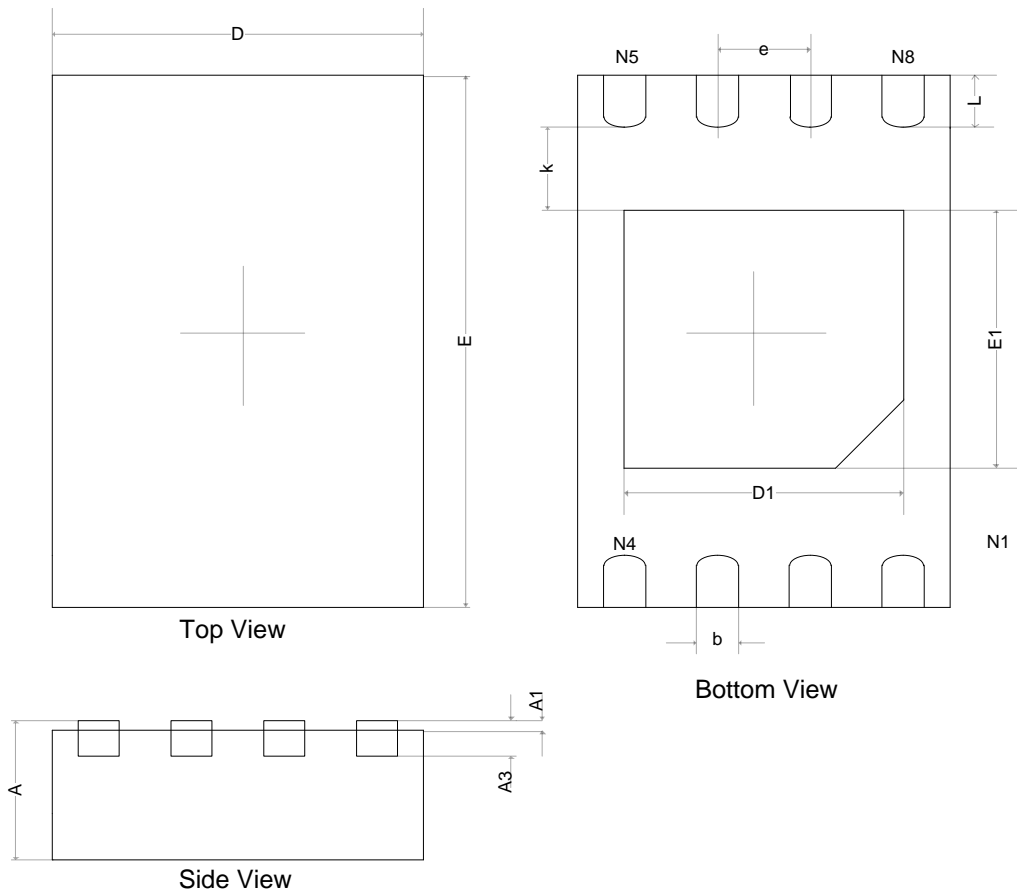
Package Information

MSOP8L PACKAGE OUTLINE DIMENSIONS



| SYMBOL | MILLIMETER | |
|--------|------------|------|
| | MIN. | MAX. |
| A | | 1.10 |
| A1 | 0.05 | 0.15 |
| A2 | 0.75 | 0.95 |
| A3 | 0.30 | 0.40 |
| b | 0.29 | 0.38 |
| b1 | 0.28 | 0.33 |
| c | 0.15 | 0.20 |
| c1 | 0.14 | 0.16 |
| D | 2.9 | 3.1 |
| E | 4.7 | 5.1 |
| E1 | 2.9 | 3.1 |
| e | 0.65BSC | |
| L | 0.40 | 0.70 |
| L1 | 0.95BSC | |

DFN3X4-8L PACKAGE OUTLINE DIMENSIONS



| SYMBOL | MILLIMETER | | |
|--------|------------|------|------|
| | MIN. | NOM. | MAX. |
| A | 0.70 | 0.75 | 0.80 |
| A1 | - | 0.02 | 0.05 |
| A3 | 0.18 | 0.20 | 0.25 |
| D | 2.90 | 3.00 | 3.10 |
| E | 3.90 | 4.00 | 4.10 |
| D1 | 2.20 | 2.30 | 2.40 |
| E1 | 1.70 | 1.80 | 1.90 |
| K | 0.230MIN. | | |
| b | 0.15 | 0.20 | 0.25 |
| e | 0.65TYP. | | |
| L | 0.35 | 0.40 | 0.45 |

Revision History

| DATE | VERSION | CHANGED ITEM | WRITTEN BY | APPROVED BY |
|------------|---------|---|------------|-------------|
| 2015-12-24 | 1.0 | New document established | Kang | Jun |
| 2016-07-10 | 1.1 | 1. Corrects the format 2. Revised Open-wire Detection Delay | Kang | Jun |
| 2016-11-10 | 1.2 | 1.Revised CW1051ALAM parameter 2. Add CW1051ALEM Ordering Information | Kang | Jun |
| 2017-08-02 | 1.3 | Add CW1051ALFM/ALFD Ordering Information | Kang | Jun |
| 2017-10-17 | 1.4 | Add CW1051ALGD Ordering Information | Kang | Jun |
| 2017-11-17 | 1.5 | 1. Add CW1051ALHD/ALJM/ALKM Ordering Information 2. Revised V_{OCR} parameter | Kang | Jun |
| 2018-02-05 | 1.6 | 1.Add CW1051ALLM/ ALHM Ordering Information 2.Add Product Name 3.R6 parameter range modify to 200 Ω ~1000 Ω . 4.CO PIN voltage range modify to -0.3V~VDD+0.3V. | Kang | Jun |
| 2018-3-12 | 1.7 | Add CW1051ALMM Ordering Information | Kang | Jun |
| 2018-4-18 | 1.8 | Add Reference Schematic | Kang | Jun |
| 2018-6-19 | 1.9 | Add CW1051ALOM\ ALPM\ ALQD \ALGM Ordering Information | Kang | Jun |
| 2018-9-7 | 2.0 | Add CW1051ALSM Ordering Information | Kang | Jun |
| 2018-9-7 | 2.1 | Add CW1051ALRM Ordering Information | Kang | Jun |
| 2018-12-17 | 2.2 | 1.Add CW1051ALUM Ordering Information 2.Add ESD Ratings 3. Revised CO High Output Drive Ability parameter | Kang | Jun |

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